U2J Dielectric, 10 - 50 VDC (Commercial Grade)



Overview

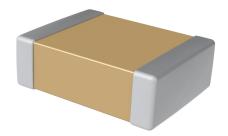
KEMET's U2J dielectric features a maximum operating temperature of 125°C and is considered stable. The Electronics Industries Alliance (EIA) characterizes U2J dielectric as a Class I material. Components of this classification are temperature compensating and are suited for resonant circuit applications or those where Q and stability of capacitance characteristics are required. U2J is an extremely stable dielectric material that exhibits a negligible shift in capacitance with respect to voltage and boasts a predictable and linear change in capacitance with reference to ambient temperature with no aging effect. In addition, U2J dielectric extends the available capacitance range

of Class I MLCCs to achieve values previously only available using Class II dielectric materials like X7R, X5R, Y5V and Z5U. U2J is not sensitive to DC Bias as compared to Class II dielectric materials and retains over 99% of nominal capacitance at full rated voltage.

Capacitance change is limited to -750 ± 120 ppm /°C from -55°C to +125°C. These devices are Lead-free, RoHS and REACH compliant without exception and are capable of withstanding multiple passes through a Lead-free solder reflow profile.

Benefits

- Operating temperature range of -55°C to +125°C
- · Lead (Pb)-free, RoHS and REACH compliant
- EIA 0402, 0603, 0805, 1206, 1210 and 1812 case sizes
- DC voltage ratings of 10 V, 16 V, 25 V and 50 V
- Capacitance offerings ranging from 1.0 nF up to 470 nF
- Available capacitance tolerances of ±1%, ±2%, ±5%, ±10% and ±20%
- Low noise solution similar to C0G
- Low dissipation factor DF < 0.1%
- Low ESR & ESL
- · High thermal stability
- · High ripple current capability



Ordering Information

C	1206	C	104	J	3	J	A	С	TU
Ceramio	Case Size (L" x W")	Specification/ Series ¹	Capacitance Code (pF)	Capacitance Tolerance ²	Rated Voltage (VDC)	Dielectric	Failure Rate/ Design	Termination Finish ³	Packaging/Grade (C-Spec)
	0402 0603 0805 1206 1210 1812	C = Standard	Two significant digits + number of zeros.	F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	8 = 10 4 = 16 3 = 25 5 = 50	J = U2J	A = N/A	C = 100% Matte Sn	See "Packaging C-Spec Ordering Options Table" below

¹ Flexible termination option is available. Please see FT-CAP product bulletin C1062_C0G_FT-CAP_SMD

² Additional capacitance tolerance offerings may be available. Contact KEMET for details.



Packaging C-Spec Ordering Options Table

Packaging Type ¹	Packaging/Grade Ordering Code (C-Spec)
Bulk Bag/Unmarked	Not required (Blank)
7" Reel/Unmarked	TU
13" Reel/Unmarked	7411 (EIA 0603 and smaller case sizes) 7210 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch ²	7081
13" Reel/Unmarked/2 mm pitch ²	7082

¹ Default packaging is "Bulk Bag". An ordering code C-Spec is not required for "Bulk Bag" packaging.

Benefits cont'd

- Preferred capacitance solution at line frequencies & into the MHz range
- · Small predictable and linear capacitance change with respect to temperature
- · Non-polar device, minimizing installation concerns
- 100% pure matte Tin-plated termination finish allowing for excellent solderability
- Retains 99% of nominal capacitance at full rated voltage

Applications

Typical applications include critical timing, tuning, circuits requiring low loss, circuits with pulse, high current, decoupling, bypass, filtering, transient voltage suppression and blocking, as well as energy storage in critical and safety relevant circuits without (integrated) current limitation, including those subject to high levels of board flexure or temperature cycling.

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance and Reliability.

Environmental Compliance

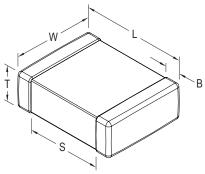
Lead (Pb)-Free, RoHS, and REACH compliant without exemptions.

¹ The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. The option to laser mark is not available on these devices. For more information see "Capacitor Marking".

² The 2 mm pitch option allows for double the packaging quantity of capacitors on a given reel size. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".



Dimensions – Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0402	1005	1.00 (0.040)±0.05 (0.002)	0.50 (0.020)± 0.05 (0.002)		0.30 (0.012)±0.10 (0.004)	0.30 (0.012)	
0603	1608	1.60 (0.063)±0.15 (0.006)	0.80 (0.032)±0.15 (0.006)		0.35 (0.014)±0.15 (0.006)	0.70 (0.028)	Solder wave
0805	2012	2.00 (0.079)±0.20 (0.008)	1.25 (0.049)±0.20 (0.008)		0.50 (0.02)±0.25 (0.010)	0.75 (0.030)	or
1206	3216	3.20 (0.126)±0.20 (0.008)	1.60 (0.063)±0.20 (0.008)		0.50 (0.02)±0.25 (0.010)		Solder reflow
1210	3225	3.20 (0.126)±0.20 (0.008)	2.50 (0.098)±0.20 (0.008)		0.50 (0.02)±0.25 (0.010)	N/A	Caldan naflass and
1812	4532	4.50 (0.177)±0.30 (0.012)	3.20 (0.126)±0.30 (0.012)		0.60 (0.024)±0.35 (0.014)		Solder reflow only



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	−750 ±120 ppm/°C
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	0.1%
Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5 ±1 seconds and charge/discharge not exceeding 50 mA)
Dissipation Factor (DF) Maximum Limit at 25°C	0.1%
Insulation Resistance (IR) Limit at 25°C	1,000 megohm microfarads or 100 G Ω (Rated voltage applied for 120 ± 5 seconds at 25°C)

To obtain IR limit, divide $M\Omega$ - μ F value by the capacitance and compare to $G\Omega$ limit. Select the lower of the two limits. Capacitance and dissipation factor (DF) measured under the following conditions:

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

	High Temperature Life, Biased Humidity, Moisture Resistance												
Dielectric	Rated DC Voltage	Capacitance Value	Dissipation Factor (Maximum %)	Capacitance Shift	Insulation Resistance								
U2J	All	All	0.5	0.3% or ±0.25 pF	10% of Initial Limit								

¹ MHz ±100 kHz and 1.0 Vrms ±0.2 V if capacitance ≤ 1,000 pF

¹ kHz ± 50 Hz and 1.0 Vrms ± 0.2 V if capacitance > 1,000 pF



Table 1A – Capacitance Range/Selection Waterfall (0402 – 1812 Case Sizes)

		Case Size/ Series		C04	02C			C06	03C	;		C08	05C	;		C12	06C			C12	10C	;		C18	12C	
Capacitance	Cap	Voltage Code	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5
	Code	Rated Voltage (VDC)	9	16	25	20	9	16	25	20	9	16	25	20	9	9	25	20	10	91	25	20	9	16	25	20
		Capacitance					Pro	duc	t Av	ailal	oility	and	l Ch	ip TI	ı hickı	ness	Cod	des								
		Tolerance					<u>s</u>	ee T	able	2 fc	or Ci	nip T	hick	ines	s Di	men	sion	s								
100 pF 110 pF	101 111	F G J K M F G J K M	BB BB	BB BB	BB BB	BB BB																				
120 pF	121	F G J K M	BB	BB	BB	BB																				
130 pF	131	F G J K M	ВВ	ВВ	BB	BB																				
150 pF	151	F G J K M	ВВ	ВВ	BB	BB																				
160 pF	161	F G J K M	ВВ	BB	BB	BB																				
180 pF	181	F G J K M	BB	BB	BB	BB																				
200 pF	201 221	F G J K M	BB BB	BB BB	BB BB	BB BB									ŀ											
220 pF 240 pF	241	F G J K M F G J K M	BB	BB	BB	BB																				
270 pF	271	F G J K M	BB	BB	BB	BB																				
300 pF	301	F G J K M	BB	BB	BB	BB																				
330 pF	331	F G J K M	ВВ	ВВ	BB	BB																				
360 pF	361	F G J K M	ВВ	ВВ	ВВ	ВВ																				
390 pF	391	F G J K M	ВВ	ВВ	ВВ	ВВ																				
430 pF	431	F G J K M	BB	BB	BB	BB																				
470 pF	471	F G J K M	BB	BB	BB	BB																				
510 pF 560 pF	511 561	F G J K M	BB BB	BB BB	BB BB	BB BB																				
620 pF	621	F G J K M	BB	BB	BB	BB																				
680 pF	681	F G J K M	BB	BB	BB	BB																				
750 pF	751	F G J K M	BB	BB	BB	BB																				
820 pF	821	F G J K M	ВВ	ВВ	BB	BB																				
910 pF	911	F G J K M	ВВ	ВВ	BB	BB																				
1,000 pF	102	F G J K M	BB	BB	BB	BB	CF	CF	CF	CF																
1,100 pF	112	F G J K M	BB	BB	BB	BB	CF	CF	CF	CF																
1,200 pF	122	F G J K M	BB	BB	BB	BB	CF	CF	CF	CF																
1,300 pF 1,500 pF	132 152	F G J K M	BB BB	BB BB	BB BB	BB BB	CF CF	CF CF	CF CF	CF CF																
1,600 pF	162	F G J K M F G J K M	BB	BB	ВВ	ВВ	CF	CF	CF	CF																
1,800 pF	182	F G J K M	BB	BB	BB	BB	CF	CF	CF	CF																
2,000 pF	202	F G J K M	ВВ	ВВ	BB		CF	CF	CF	CF																
2,200 pF	222	F G J K M	ВВ	ВВ	BB		CF	CF	CF	CF													İ			
2,400 pF	242	F G J K M					CF	CF	CF	CF																
2,700 pF	272	F G J K M					CF	CF	CF	CF																
3,000 pF	302	F G J K M					CF	CF	CF	CF																
3,300 pF	332 362	F G J K M					CF CF	CF CF	CF CF	CF CF																
3,600 pF 3,900 pF	362 392	F G J K M F G J K M					CF	CF	CF	CF																
4,300 pF	432	F G J K M					CF	CF	CF	CF													l			
4,700 pF	472	F G J K M					CF	CF	CF		DN	DN	DN	DN												
5,100 pF	512	F G J K M					CF	CF	CF	CF	DN	DN	DN	DN												
5,600 pF	562	F G J K M					CF	CF	CF	CF	DN	DN	DN	DN												
6,200 pF	622	F G J K M					CF	CF	CF	CF	DN	DN	DN	DN												
6,800 pF	682	F G J K M					CF	CF	CF	CF	DN	DN	DN	DN												
7,500 pF 8,200 pF	752 822	F G J K M					CF CF	CF CF	CF CF	CF CF	DN DN	DN	DN DN	DN DN												
8,200 pF 9,100 pF	912	F G J K M F G J K M					CF	CF	CF	CF	DN	DN DN	DN	DN												
10,000 pF	103	F G J K M					CF	CF	CF	CF	DN	DN	DN	DN	EB	EB	EB	EB	FB	FB	FB	FB	GB	GB	GB	
12,000 pF	123	F G J K M					CF	CF	CF		DN	DN	DN	DN	EB	EB	EB	EB	FB	FB	FB	FB	GB	GB	GB	
15,000 pF	153	F G J K M					CF	CF	CF		DN	DN	DN	DN	EB	EB	EB	EB	FB	FB	FB	FB	GB	GB	GB	
		Rated Voltage (VDC)	9	16	25	20	10	16	25	20	ę	16	25	20	ę	9	25	20	10	9	25	20	9	9	25	20
Capacitance	Cap	Voltage Code	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5
	Code	Case Size/Series			02C			C06				C08				C12	_				10C			C18		
		1 335 5.20, 55, 100	Щ.	1											L									0		



Table 1A - Capacitance Range/Selection Waterfall (0402 - 1812 Case Sizes) cont'd

	Con	Case Size/ Series		C04	02C			C06	03C			C08	05C			C12	06C			C12	10C			C18	12C	
Capacitance	Cap	Voltage Code	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5
·	Code	Rated Voltage (VDC)	10	16	25	50	10	16	25	20	10	16	25	20	10	16	25	20	2	9	25	20	9	16	25	50
		Capacitance Tolerance					Pro	duc ee T	t Av	ailal 2 fc	oility or Ch	and	l Chi hick	ip Tł	nickr s Dir	ness men	Coo	des s								
18,000 pF	183	F G J K M									DN	DN	DN	DN	EB	EB	EB	EB	FB	FB	FB	FB	GB	GB	GB	
22,000 pF	223	F G J K M									DN	DN	DN	DP	EB	EB	EB	EB	FB	FB	FB	FB	GB	GB	GB	
27,000 pF	273	F G J K M									DP	DP	DP	DP	EB	EB	EB	EB	FB	FB	FB	FB	GB	GB	GB	
33,000 pF	333	F G J K M									DP	DP	DP	DG	EB	EB	EB	EB	FB	FB	FB	FB	GB	GB	GB	
47,000 pF	393	F G J K M									DG	DG	DG	DG	EB	EB	EB	EB	FB	FB	FB	FB	GB	GB	GB	
47,000 pF	473	F G J K M									DG	DG	DG	DG	EB	EB	EB	EB	FB	FB	FB	FB	GB	GB	GB	
56,000 pF	563	F G J K M									DG	DG	DG		EB	EB	EB	EC	FB	FB	FB	FB	GB	GB	GB	
68,000 pF	683	F G J K M													EC	EC	EC	EC	FB	FB	FB	FB	GB	GB	GB	
82,000 pF	823	F G J K M													EC	EC	EC	EE	FB	FB	FB	FB	GB	GB	GB	
100,000 pF	104	F G J K M													EC	EC	EC	EF	FB	FB	FB	FC	GB	GB	GB	
120,000 pF	124	F G J K M													EF	EF	EF	EH	FC	FC	FC	FE	GB	GB	GB	
150,000 pF	154	F G J K M													EF	EF	EF	EH	FE	FE	FE	FG	GB	GB	GB	
180,000 pF	184	F G J K M													EH	EH	EH		FG	FG	FG	FG	GB	GB	GB	
220,000 pF	224	F G J K M													EH	EH	EH		FG	FG	FG	FH	GB	GB	GB	
270,000 pF	274	F G J K M																	FH	FH	FH	FM	GB	GB	GB	
330,000 pF	334	F G J K M																	FM	FM	FM		GC	GC	GC	
390,000 pF	394	F G J K M																	•				GH	GH	GH	
470,000 pF	474	F G J K M																					GK	GK	GK	
	0	Rated Voltage (VDC)	9	16	25	50	9	9	25	20	9	9	25	20	9	9	25	20	2	9	25	20	9	16	25	20
Capacitance	Cap Code	Voltage Code	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5	8	4	3	5
		Case Size/Series		C04	02C			C06	03C			C08	05C			C12	06C			C12	10C			C18	12C	



Table 2A – Chip Thickness/Tape & Reel Packaging Quantities

Thickness	Case	Thickness ±	Paper Q	uantity ¹	Plastic (Quantity
Code	Size ¹	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel
BB	0402	0.50 ± 0.05	10,000	50,000	0	0
BD	0402	0.55 ± 0.05	10,000	50,000	0	0
CF	0603	0.80 ± 0.07	4,000	15,000	0	0
CH	0603	0.85 ± 0.07	4,000	10,000	0	0
DM	0805	0.70 ± 0.20	4,000	15,000	0	0
DN	0805	0.78 ± 0.10	4,000	15,000	0	0
DP	0805	0.90 ± 0.10	4,000	15,000	0	0
DE	0805	1.00 ± 0.10	0	0	2,500	10,000
DF	0805	1.10 ± 0.10	0	0	2,500	10,000
DG	0805	1.25 ± 0.15	0	0	2,500	10,000
EB	1206	0.78 ± 0.10	4,000	10,000	4,000	10,000
EC	1206	0.90 ± 0.10	0	0	4,000	10,000
ED	1206	1.00 ± 0.10	0	0	2,500	10,000
EE	1206	1.10 ± 0.10	0	0	2,500	10,000
EF	1206	1.20 ± 0.15	0	0	2,500	10,000
EH	1206	1.60 ± 0.20	0	0	2,000	8,000
FB	1210	0.78 ± 0.10	0	0	4,000	10,000
FC	1210	0.90 ± 0.10	0	0	4,000	10,000
FE	1210	1.00 ± 0.10	0	0	2,500	10,000
FF	1210	1.10 ± 0.10	0	0	2,500	10,000
FG	1210	1.25 ± 0.15	0	0	2,500	10,000
FH	1210	1.55 ± 0.15	0	0	2,000	8,000
FM	1210	1.70 ± 0.20	0	0	2,000	8,000
FJ	1210	1.85 ± 0.20	0	0	2,000	8,000
FK	1210	2.10 ± 0.20	0	0	2,000	8,000
GB	1812	1.00 ± 0.10	0	0	1,000	4,000
GD	1812	1.25 ± 0.15	0	0	1,000	4,000
GH	1812	1.40 ± 0.15	0	0	1,000	4,000
GG	1812	1.55 ± 0.10	0	0	1,000	4,000
GK	1812	1.60 ± 0.20	0	0	1,000	4,000
GJ	1812	1.70 ± 0.15	0	0	1,000	4,000
GN	1812	1.70 ± 0.20	0	0	1,000	4,000
GM	1812	2.00 ± 0.20	0	0	500	2,000
Thickness	Case	Thickness ±	7" Reel	13" Reel	7" Reel	13" Reel
Code	Size ¹	Range (mm)	Paper Q	uantity¹	Plastic (Quantity

Package quantity based on finished chip thickness specifications.

¹ If ordering using the 2 mm Tape and Reel pitch option, the packaging quantity outlined in the table above will be doubled. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".



Table 2B - Bulk Packaging Quantities

Doolood		Loose Pa	ackaging						
Раскад	ng Type	Bulk Bag	(default)						
Packagin	g C-Spec ¹	N/	A ²						
Case	Size	Packaging Quantities (pieces/unit packaging							
EIA (in)	Metric (mm)	Minimum	Maximum						
0402	1005								
0603	1608								
0805	2012	1	50,000						
1206	3216								
1210	3225								
1812	4532		20,000						

¹ The "Packaging C-Spec" is a 4 to 8 digit code which identifies the packaging type and/or product grade. When ordering, the proper code must be included in the 15th through 22nd character positions of the ordering code. See "Ordering Information" section of this document for further details. Commercial Grade product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging. Contact KEMET if you require a bulk bag packaging option for Automotive Grade products.

² A packaging C-Spec (see note 1 above) is not required for "Bulk Bag" packaging (excluding Anti-Static Bulk Bag and Automotive Grade products). The 15th through 22nd character positions of the ordering code should be left blank. All product ordered without a packaging C-Spec will default to out standard "Bulk Bag" packaging.



Table 3 – Chip Capacitor Land Pattern Design Recommendations per IPC-7351

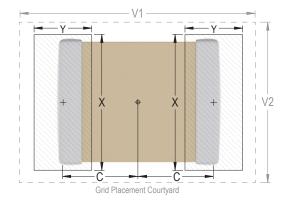
EIA Size Code	Metric Size Code			sity Lev mum (M rotrusio	lost))		Media	sity Lev an (Nor rotrusio			Density Level C: Minimum (Least) Land Protrusion (mm)						
Oode	Oode	С	Y	X	V1	V2	С	Y	X	V1	V2	С	Y	X	V1	V2		
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80		
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20		
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70		
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00		
1210	3225	1.60	1.35	2.80	5.65	3.80	1.50	1.15	2.70	4.70	3.20	1.40	0.95	2.60	4.00	2.90		
12101	3225	1.50	1.60	2.90	5.60	3.90	1.40	1.40	2.80	4.70	3.30	1.30	1.20	2.70	4.00	3.00		
1812	4532	2.15	1.60	3.60	6.90	4.60	2.05	1.40	3.50	6.00	4.00	1.95	1.20	3.40	5.30	3.70		

¹ Only for capacitance values ≥ 22 μF

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805 and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC–7351).

Image below based on Density Level B for an EIA 1210 case size.





Soldering Process

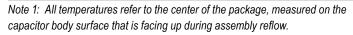
Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

Recommended Reflow Soldering Profile:

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Terminati	on Finish
Frome reature	SnPb	100% Matte Sn
Preheat/Soak		
Temperature Minimum (T _{Smin})	100°C	150°C
Temperature Maximum (T _{Smax})	150°C	200°C
Time (t_s) from T_{smin} to T_{smax}	60 – 120 seconds	60 – 120 seconds
Ramp-Up Rate (T _L to T _P)	3°C/second maximum	3°C/second maximum
Liquidous Temperature (T _L)	183°C	217°C
Time Above Liquidous (t _L)	60 – 150 seconds	60 – 150 seconds
Peak Temperature (T _P)	235°C	260°C
Time Within 5°C of Maximum Peak Temperature (t _P)	20 seconds maximum	30 seconds maximum
Ramp-Down Rate (T _P to T _L)	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum



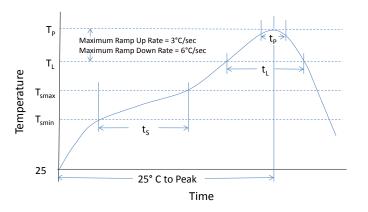




Table 4 – Performance & Reliability: Test Methods and Conditions

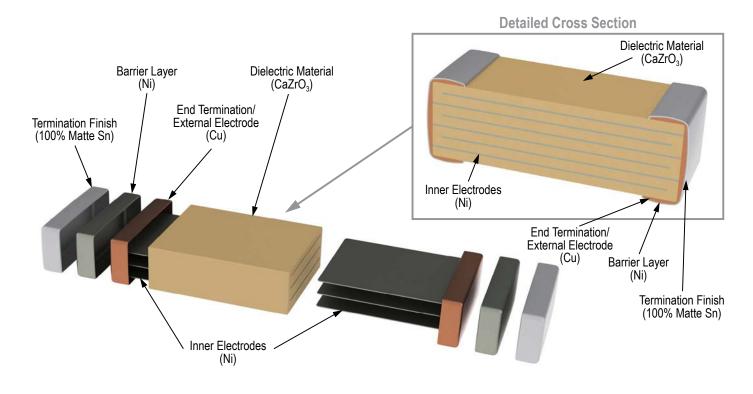
Stress	Reference		Test or Inspection	Method								
			Package Size (L" x W")	Force	Duration							
Tarminal Strangth	JIS-C-6429	Annandiy 1 Noto:	0402	5 N (0.51 kg)								
Terminal Strength	JIS-U-0429	Appendix 1, Note:	0603	10 N (1.02 kg)	60 seconds							
			≥ 0805	18 N (1.83 kg)								
Board Flex	JIS-C-6429	Appendix 2, Note: 3.0 mm (r	minimum).									
		Magnification 50 X Conditions:										
Coldorability	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C										
Solderability	J-51D-002	b) Method B at 215°C	C category 3									
		c) Method D, categor	y 3 at 260°C									
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125	5°C). Measurement at 24 hou	ırs +/- 4 hours afte	er test conclusion							
Biased Humidity	MIL-STD-202 Method 103	at 24 hours +/- 4 hours afte		· ·								
Diased Hamilalty	WILE-STD-202 Method 103	Low Volt Humidity: 1,000 ho 24 hours +/- 4 hours after to	ours 85C°/85% RH and 1.5 Vest conclusion.	. Add 100 K ohm r	esistor. Measurer	nent at						
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a conclusion.	a & 7b not required. Measure	ment at 24 hrs. +/-	- 4 hours after tes	st .						
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Numb time – 15 minutes. Air – Air.	er of cycles required – 300. I	Maximum transfer	time – 20 second	ls. Dwell						
High Temperature Life	MIL-STD-202 Method 108/EIA -198	1,000 hours at 125°C with 2	X rated voltage applied.									
Storage Life	MIL-STD-202 Method 108	125°C, 0 VDC for 1,000 hou	irs.									
Vibration	MIL-STD-202 Method 204	5 G's for 20 minutes, 12 cyc points on one long side and from any secure point. Test	les each of 3 orientations. No 2 secure points at corners o from 10 – 2,000 Hz	ote: Use 8" X 5" P0 f opposite sides. P	CB 0.031" thick 7 arts mounted wit	secure hin 2"						
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Cor	ndition F.									
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemica	al, OKEM clean or equivalent									

Storage and Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature- reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



Construction



Capacitor Marking (Optional):

Laser marking option is not available on:

- C0G, Ultra Stable X8R and Y5V dielectric devices
- EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- · KPS Commercial and Automotive grade stacked devices.

These capacitors are supplied unmarked only.



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

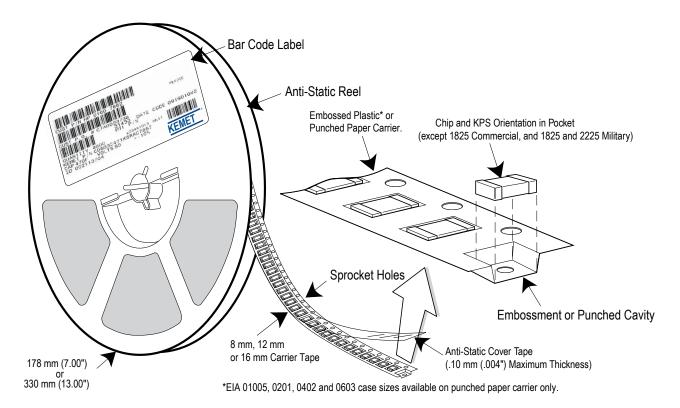


Table 5 – Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

	Tape	Embossed Plastic		Punched Paper	
EIA Case Size	Size (W)*	7" Reel	13" Reel	7" Reel	13" Reel
		Pitch (P ₁)*		Pitch (P ₁)*	
01005 – 0402	8			2	2
0603	8			2/4	2/4
0805	8	4	4	4	4
1206 – 1210	8	4	4	4	4
1805 – 1808	12	4	4		
≥ 1812	12	8	8		
KPS 1210	12	8	8		
KPS 1812 & 2220	16	12	12		
Array 0508 & 0612	8	4	4		

^{*}Refer to Figures 1 & 2 for W and P, carrier tape reference locations.

New 2 mm Pitch Reel Options*

Packaging Ordering Code (C-Spec)	Packaging Type/Options
C-3190	Automotive grade 7" reel unmarked
C-3191	Automotive grade 13" reel unmarked
C-7081	Commercial grade 7" reel unmarked
C-7082	Commercial grade 13" reel unmarked

^{* 2} mm pitch reel only available for 0603 EIA case size. 2 mm pitch reel for 0805 EIA case size under development.

Benefits of Changing from 4 mm to 2 mm Pitching Spacing

- Lower placement costs
- Double the parts on each reel results in fewer reel changes and increased efficiency
- Fewer reels result in lower packaging, shipping and storage costs, reducing waste

^{*}Refer to Tables 6 & 7 for tolerance specifications.



Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

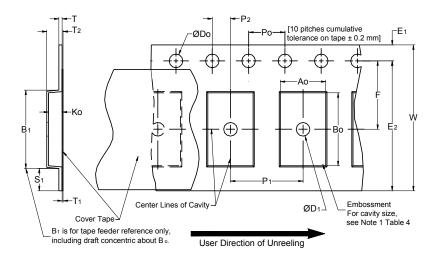


Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum
8 mm		1.0 (0.039)				25.0 (0.984)			
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)		4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30 (1.181)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)	
16 mm	(0.059)								
	Variable Dimensions — Millimeters (Inches)								
Tape Size	e Size Pitch B ₁ Maximum E ₂ F P ₁ T ₂ W A ₀ ,B ₀ & K ₀						& K ₀		
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)		
12 mm	Single (4 mm) & Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Note 5	
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)		

- 1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).
- 3. If S₄ < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481 paragraph 4.3 section b).
- 4. B, dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by A_{α} , B_{α} and K_{α} shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4).
 - (e) for KPS Series product, A_0 and B_0 are measured on a plane 0.3 mm above the bottom of the pocket.
 - (f) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.



Figure 2 – Punched (Paper) Carrier Tape Dimensions

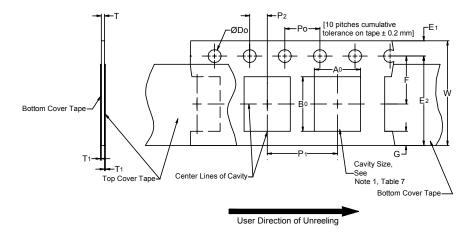


Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)								
Tape Size	D ₀	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2	
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) Maximum	0.75 (0.030)	25 (0.984)	
	Variable Dimensions — Millimeters (Inches)							
Tape Size	Pitch	E2 Minimum	F	P ₁	T Maximum	W Maximum	A_0B_0	
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1	
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	Note 1	

- 1. The cavity defined by A_n, B_n and T shall surround the component with sufficient clearance that:
 - a) the component does not protrude beyond either surface of the carrier tape.
 - b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - c) rotation of the component is limited to 20° maximum (see Figure 3).
 - d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4).
 - e) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).



Packaging Information Performance Notes

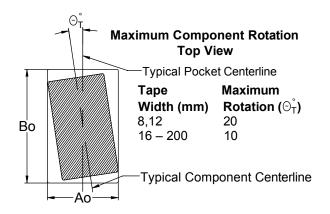
- 1. Cover Tape Break Force: 1.0 Kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength		
8 mm	0.1 to 1.0 Newton (10 to 100 gf)		
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)		

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ± 10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624.*

Figure 3 – Maximum Component Rotation



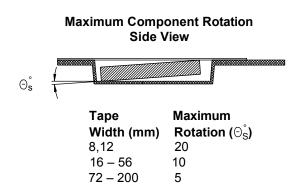


Figure 4 - Maximum Lateral Movement

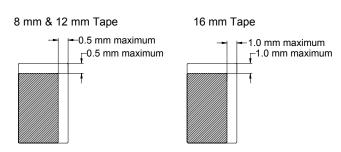


Figure 5 - Bending Radius

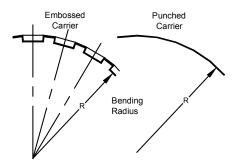
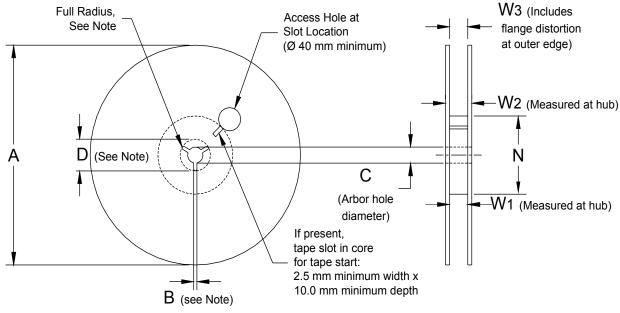




Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 8 - Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	A	B Minimum	С	D Minimum					
8 mm	178 ±0.20								
12 mm	(7.008 ±0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)					
16 mm	330 ±0.20 (13.000 ±0.008)								
	Variable Dimensions — Millimeters (Inches)								
Tape Size	N Minimum	W ₁	W ₂ Maximum	W_3					
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)						
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference					
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)						



Figure 7 – Tape Leader & Trailer Dimensions

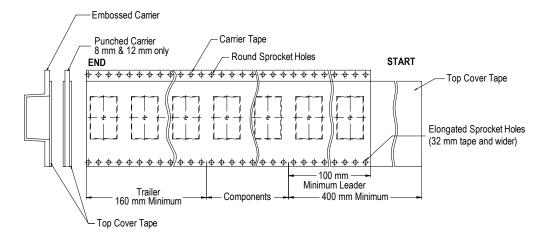
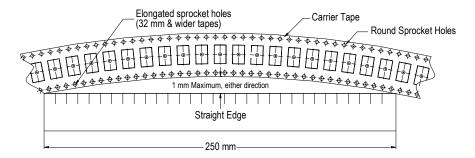


Figure 8 – Maximum Camber





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